

ProLight PBSD-20KLA-Ux
20W UV Power LED
Technical Datasheet
Version: 1.1

ProLight Opto ® ProEngine Series

Features

- High Efficacy 20W UV LED
- Dimension: 7 mm(L) x 7mm(W)
- RoHS compliant

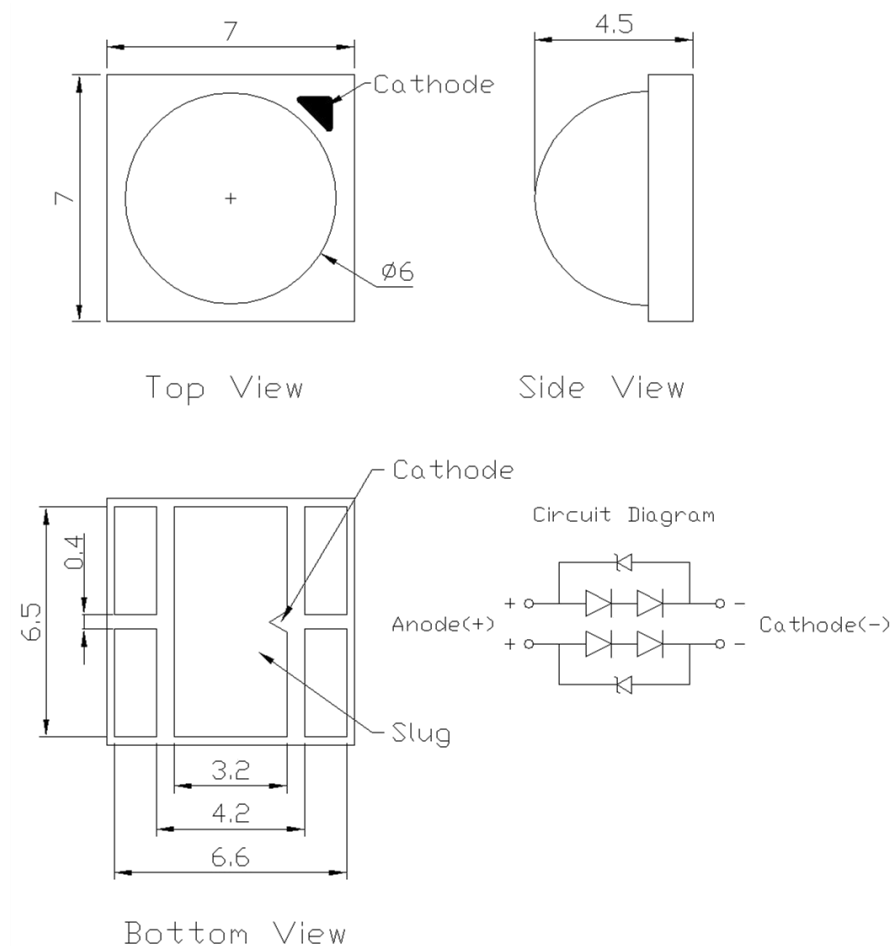
Main Applications

- UV gluing, UV curing, UV marking
- UV drying of printing inks and lacquers
- Currency inspection
- Forensic analysis-urine, protein stains
- Leak detection using fluorescent dyes
- Detects fluorescing minerals and gems

Introduction

·The PBSD-20KLA product series is a compact, high quality and reliable 4-chip UV LED. Featuring high radiometric power density and design flexibility.

Emitter Mechanical Dimensions



Notes:

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are ± 0.15 mm.
4. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
5. **Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

*The appearance and specifications of the product may be modified for improvement without notice.

Flux Characteristics, $T_j = 25^\circ\text{C}$

Radiation Pattern	Color	Part Number Emitter	Radiometric Power (mW)			
			@1000mA		Refer @2000mA	Refer @3000mA
			Minimum	Typical	Typical	Typical
Lambertian	UV-S	PBSD-20KLA-US	2000	3000	5400	-
	UV-M	PBSD-20KLA-UM	2500	3610	-	9930
	UV	PBSD-20KLA-U	2500	3610	-	9930
	UV-L	PBSD-20KLA-UL	2500	3610	-	9930
	UV-P	PBSD-20KLA-UP	2500	3610	-	9930

- ProLight maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics, $T_j = 25^\circ\text{C}$

Color	Min.	Forward Voltage V_F (V)			Refer @2000mA	Refer @3000mA	Thermal Resistance Junction to Slug ($^\circ\text{C/W}$)
		@1000mA	Typ.	Max.	Typ.	Typ.	
UV-S	6.4	7.4	8.4	7.8	-	-	2
UV-M	6.0	6.8	7.6	-	7.3	-	2
UV	6.0	6.8	7.6	-	7.3	-	2
UV-L	6.0	6.8	7.6	-	7.3	-	2
UV-P	6.0	6.8	7.6	-	7.3	-	2

- ProLight maintains a tolerance of $\pm 0.1\text{V}$ for Voltage measurements.

Optical Characteristics at 1000mA, $T_j = 25^\circ\text{C}$

Radiation Pattern	Color	Peak Wavelength λ_P			Total included Angle (degrees) $\theta_{0.90V}$	Viewing Angle (degrees) $2\theta_{1/2}$
		Min.	Typ.	Max.		
Lambertian	UV-S	365 nm	367.5 nm	370 nm	75	60
	UV-M	385 nm	387.5 nm	390 nm	75	60
	UV	390 nm	395 nm	400 nm	75	60
	UV-L	400 nm	405 nm	410 nm	75	60
	UV-P	410 nm	415 nm	420 nm	75	60

- ProLight maintains a tolerance of $\pm 1\text{nm}$ for dominant wavelength measurements.

Absolute Maximum Ratings

Parameter	UV-S	UV-M/UV/UV-L/UV-P
DC Forward Current (mA)	2000	3000
Peak Pulsed Forward Current (mA)	2200	3300
	(less than 1/10 duty cycle@1KHz)	
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)		±4000V
LED Junction Temperature		125°C
Operating Board Temperature at Maximum DC Forward Current		-40°C - 85°C
Storage Temperature		-40°C - 100°C
Soldering Temperature		JEDEC 020c 260°C
Allowable Reflow Cycles		3
Reverse Voltage	Not designed to be driven in reverse bias	

Forward Voltage Bin Structure

Color	Bin Code	Minimum Voltage (V)	Maximum Voltage (V)
UV-S	B	6.4	6.8
	C	6.8	7.2
	D	7.2	7.6
	E	7.6	8.0
	F	8.0	8.4
UV-M	A	6.0	6.4
	B	6.4	6.8
	C	6.8	7.2
	D	7.2	7.6
UV	A	6.0	6.4
	B	6.4	6.8
	C	6.8	7.2
	D	7.2	7.6
UV-L	A	6.0	6.4
	B	6.4	6.8
	C	6.8	7.2
	D	7.2	7.6
UV-P	A	6.0	6.4
	B	6.4	6.8
	C	6.8	7.2
	D	7.2	7.6

- ProLight maintains a tolerance of $\pm 0.1V$ for Voltage measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Radiometric Power Bin Structure at 1000mA

Color	Bin Code	Minimum Radiometric Power (mW)	Maximum Radiometric Power (mW)	Available Color Bins
UV-S	A	2000	2500	All
	B	2500	3000	【1】
	C	3000	3500	【1】
	D	3500	4000	【1】
UV-M	B	2500	3000	All
	C	3000	3500	【1】
	D	3500	4000	【1】
	E	4000	4500	【1】
UV	B	2500	3000	All
	C	3000	3500	【1】
	D	3500	4000	【1】
	E	4000	4500	【1】
UV-L	B	2500	3000	All
	C	3000	3500	【1】
	D	3500	4000	【1】
	E	4000	4500	【1】
UV-P	B	2500	3000	All
	C	3000	3500	【1】
	D	3500	4000	【1】
	E	4000	4500	【1】

- ProLight maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- 【1】 The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

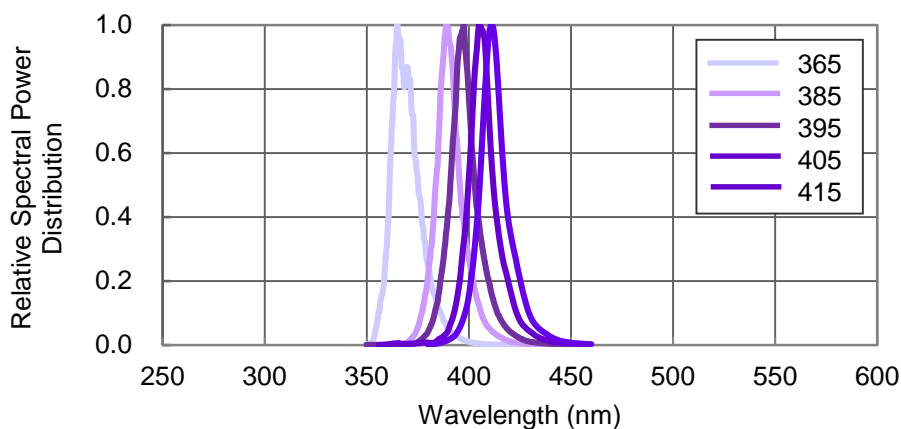
Peak Wavelength Bin Structure

Color	Bin Code	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)
UV-S	2	365	370
UV-M	A	385	390
UV	1	390	395
	2	395	400
UV-L	3	400	405
	4	405	410
UV-P	5	410	415
	6	415	420

- ProLight maintains a tolerance of $\pm 1\text{nm}$ for peak wavelength measurements.

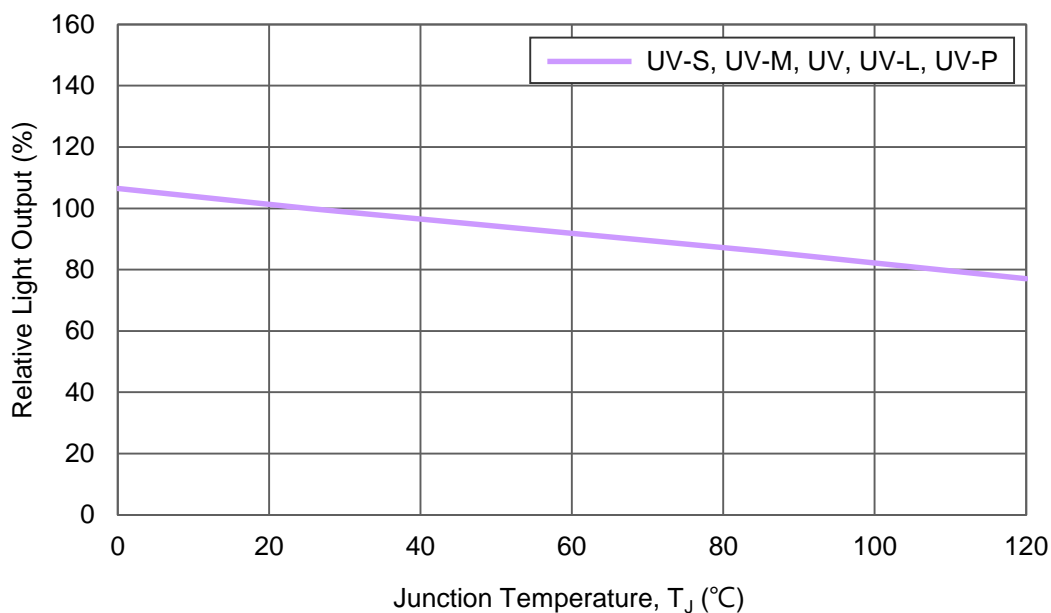
Color Spectrum, $T_j = 25^\circ\text{C}$

1. UV-S, UV-M, UV, UV-L, UV-P



Light Output Characteristics

Relative Light Output vs. Junction Temperature at 3000mA



Forward Current Characteristics, $T_j = 25^\circ\text{C}$

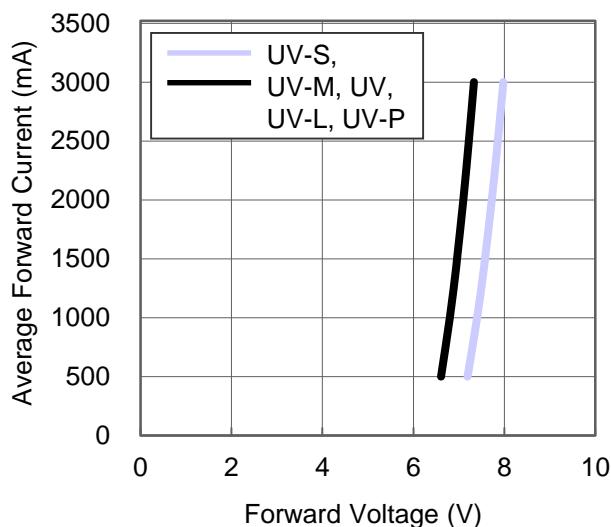


Fig 1. Forward Current vs. Forward Voltage for UV-S, UV-M, UV, UV-L, UV-P.

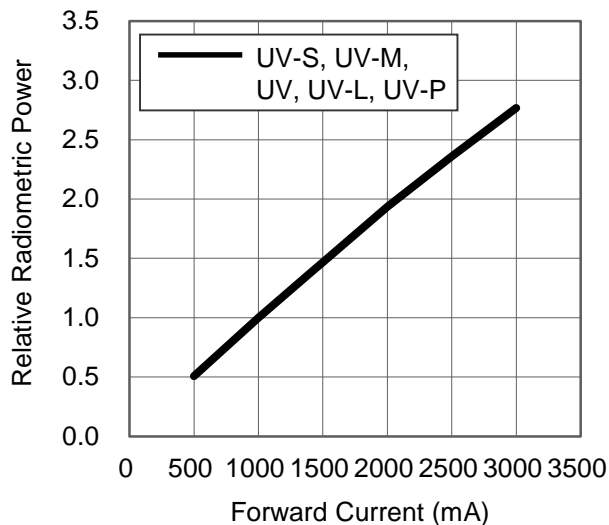
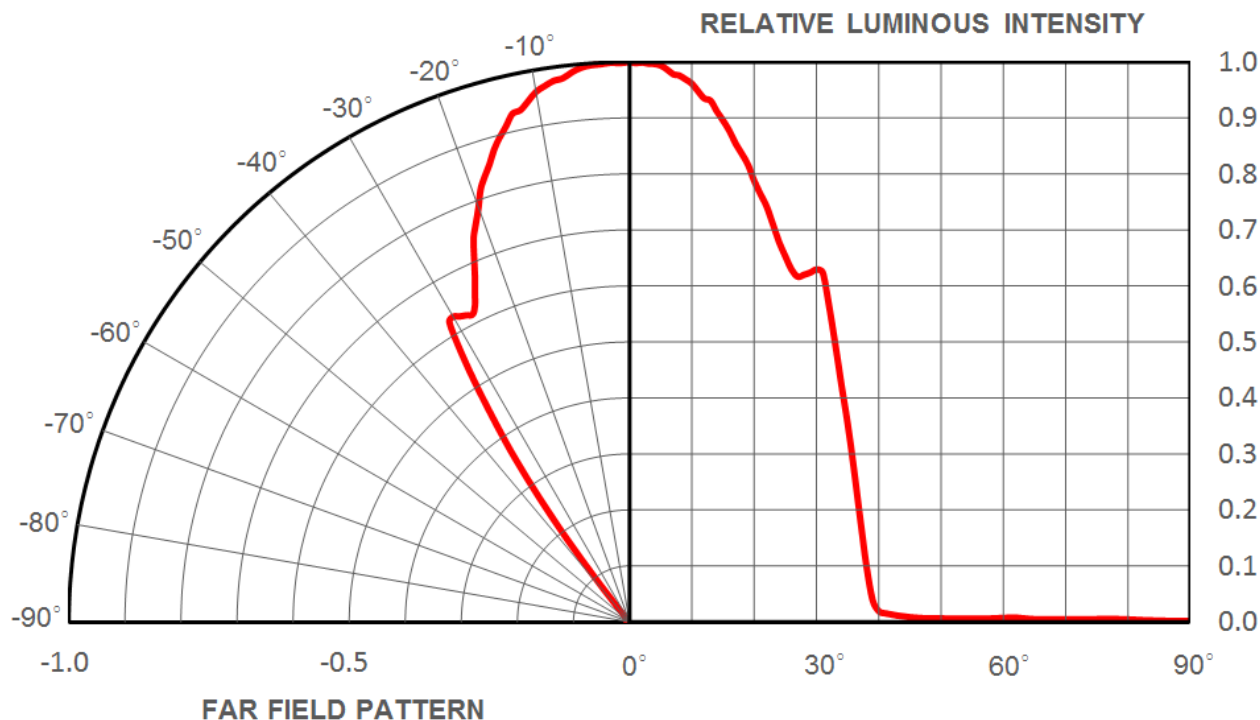


Fig 2. Relative Radiometric Power vs. Forward Current for UV-S, UV-M, UV, UV-L, UV-P at $T_j=25$ maintained.

Typical Representative Spatial Radiation Pattern



Moisture Sensitivity Level - JEDEC Level 1

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	$\leq 30^{\circ}\text{C}$ / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA

- The standard soak time includes a default value of 24 hours for semiconductor manufacture's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	$\leq 30^{\circ}\text{C}$ / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA
2	1 year	$\leq 30^{\circ}\text{C}$ / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA
2a	4 weeks	$\leq 30^{\circ}\text{C}$ / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH
3	168 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH
4	72 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH
5	48 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH
5a	24 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH
6	Time on Label (TOL)	$\leq 30^{\circ}\text{C}$ / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA

Qualification Reliability Testing

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, $I_F = \text{max DC}$ (Note 1)	1000 hours	Note 2
High Temperature Storage Life (HTSL)	100°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 100°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C \pm 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

Notes:

1. Depending on the maximum derating curve.
2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement	
		Min.	Max.
Forward Voltage (V_F)	$I_F = \text{max DC}$	--	Initial Level x 1.1
Luminous Flux or Radiometric Power (Φ_V)	$I_F = \text{max DC}$	Initial Level x 0.7	--

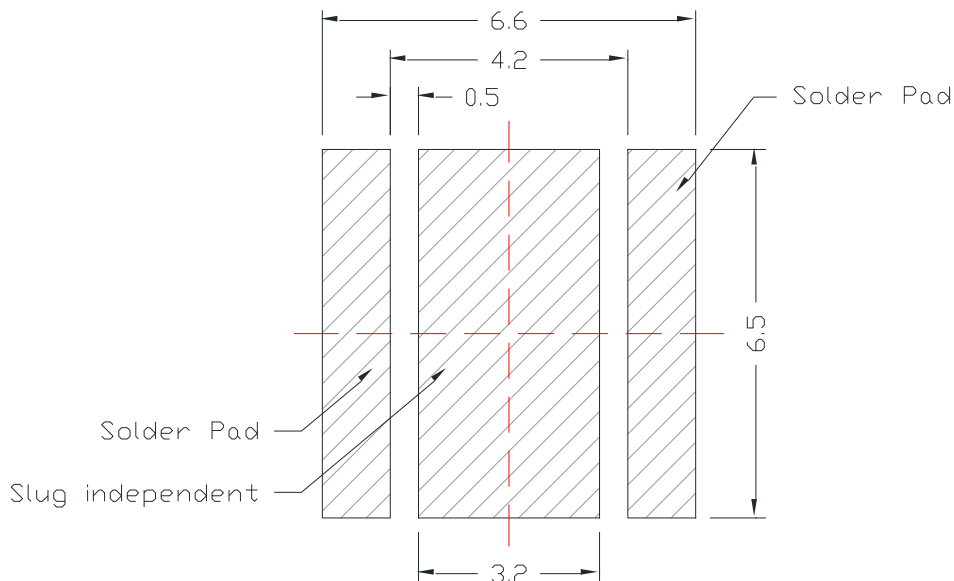
* The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

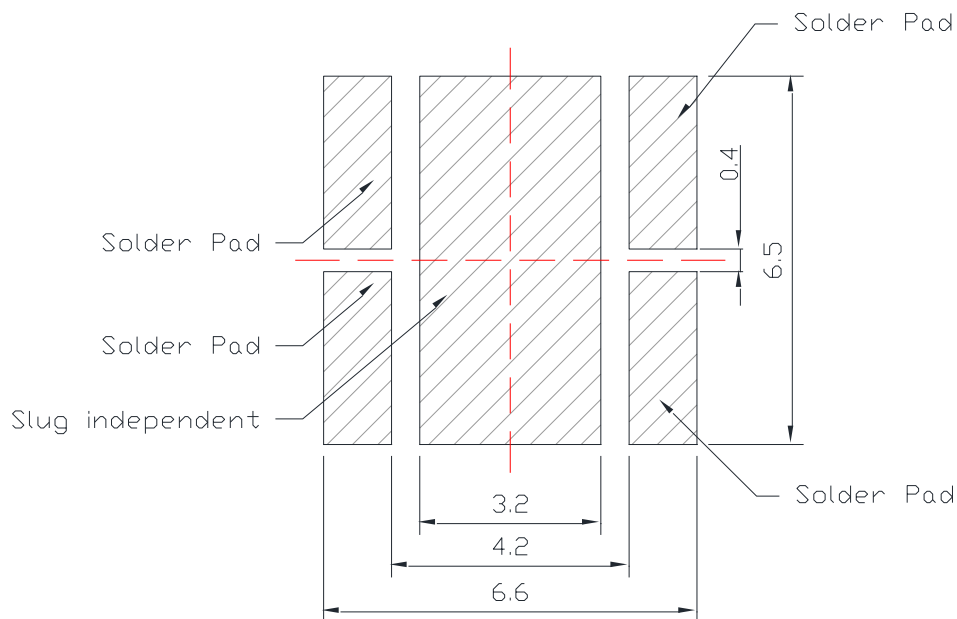
Recommended Solder Pad Design

Standard Emitter

TYPE A.

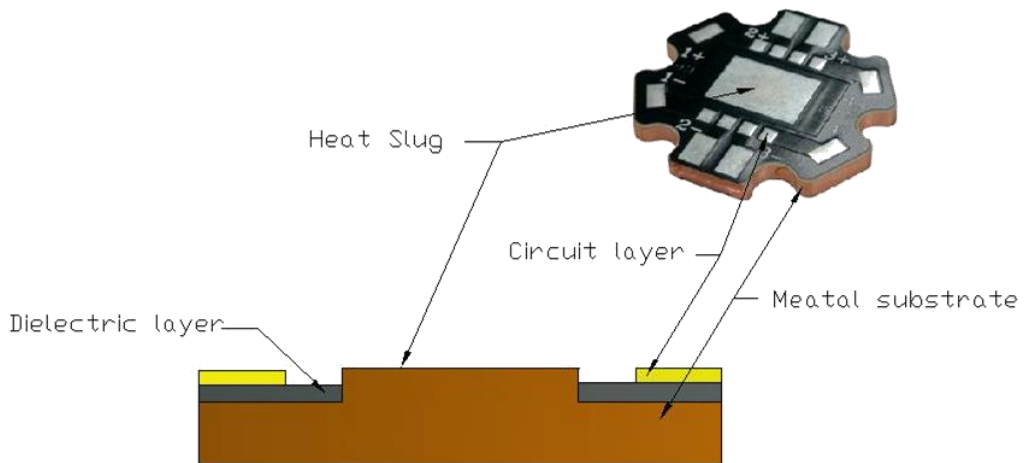


TYPE B.



- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.
- **The solder area must cover more than 80% of the solder pad and slug after soldering.**
(Voids in solder joint should be less than 20%)

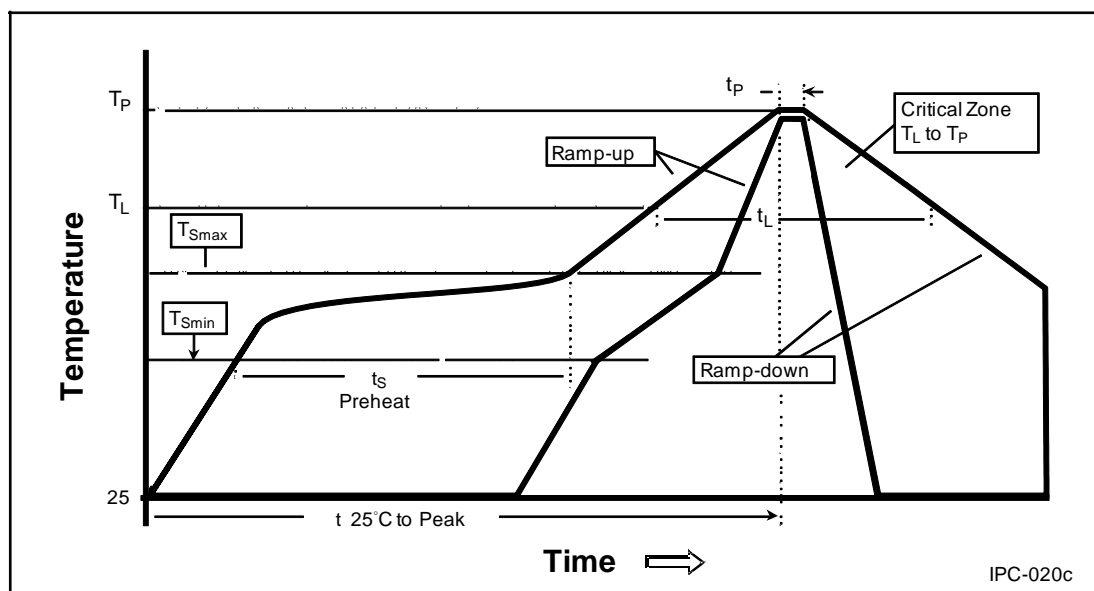
Recommended MCPCB Design



- Copper(Cu) substrate is recommended.
- The thermal conductivity of dielectric layer in the Aluminum(Al) substrate is greater or equal than 6w/mk.
- If the thermal conductivity of dielectric layer equal to 2w/mk, the power consumption should be lower than 20w.

Reflow Soldering Condition

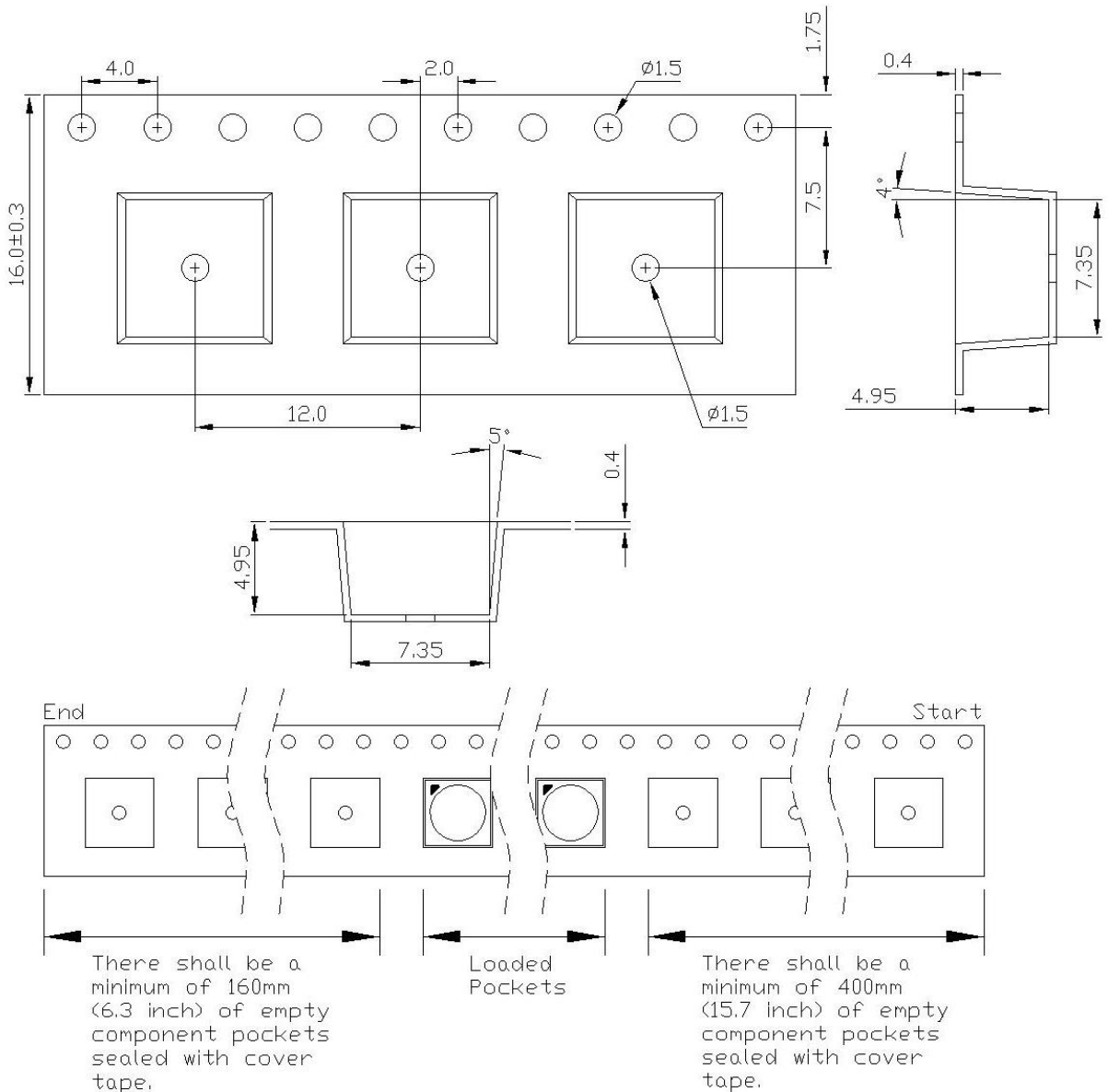
Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-Up Rate (T_{Smax} to T_p)	3°C / second max.	3°C / second max.
Preheat <ul style="list-style-type: none"> – Temperature Min (T_{Smin}) – Temperature Max (T_{Smax}) – Time (t_{Smin} to t_{Smax}) 	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: <ul style="list-style-type: none"> – Temperature (T_L) – Time (t_L) 	183°C 60-150 seconds	217°C 60-150 seconds
Peak/Classification Temperature (T_p)	240°C	260°C
Time Within 5°C of Actual Peak Temperature (t_p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

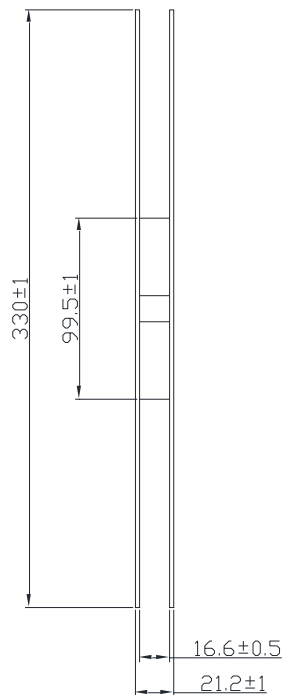
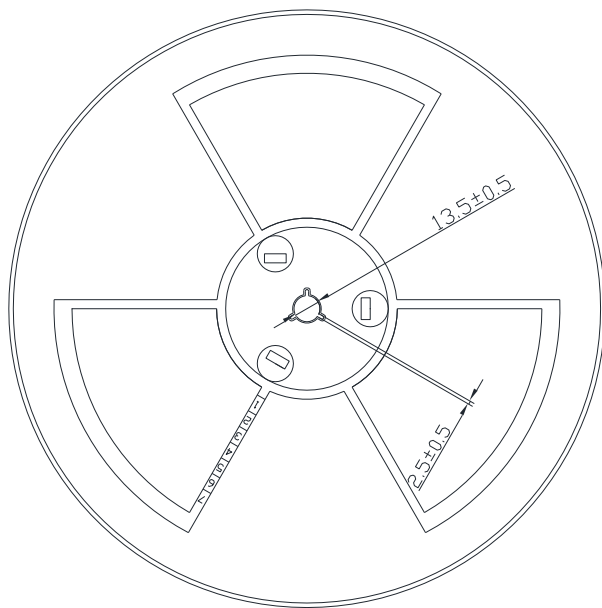


Emitter Reel Packaging



Notes:

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are ± 0.10 mm.



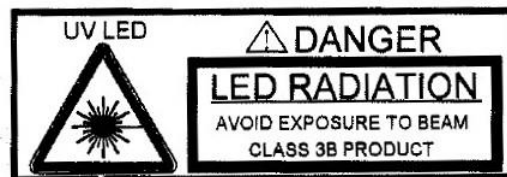
1. Empty component pockets sealed with top cover tape.
2. 250, 500 and 750 pieces per reel.
3. Drawing not to scale.
4. All dimensions are in millimeters.

Precaution for Use

- **Storage**
Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to resealed the MBB.
- LEDs are ESD (electrostatic discharge) sensitive; static electricity and surge voltages seriously damage UV LEDs and can result in product failure
 - (1) Ensure that tools, jigs and machines being used are properly grounded
 - (2) LED mounting equipment should include protection against voltage surge
 - (3) Use proper ESD protection, including grounded wrist straps, ESD footwear and clothes
- The slug is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- **We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.**
- **Do not use solder pastes with post reflow flux residue > 47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.**
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets.
<http://www.prolightopto.com/>

Eye Safety Guidelines

- During operation, the LED emits high intensity ultraviolet (UV) light, which is harmful to skin and eyes. UV light is hazardous to skin and may cause cancer. Avoid exposure to UV light when LED is operational. Precautions must be taken to avoid looking directly at the UV light without the use of UV light protective glasses. Do not look directly at the front of the LED or at the LED's lens when LED is operational.
- Attach warning labels on products/systems that use UV LEDs.



Use Handling of Quartz Lens LEDs

Notes for handling of quartz lens LEDs

- Please do not use a force of over 3kgf impact or pressure on the quartz lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the quartz lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the quartz lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the quartz lens must be prevented.
- Please do not mold over the quartz lens with another resin. (epoxy, urethane, etc)

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